



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C		
60V	12mΩ @ V _{GS} = 10V	9.8A		
	14mΩ @ V _{GS} = 4.5V	8.4A		

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

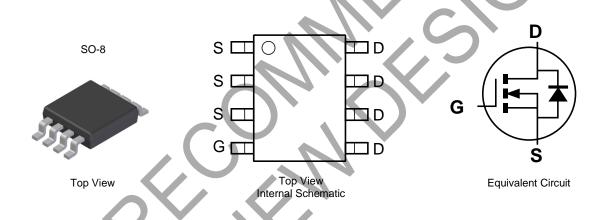
- Power Management Functions
- DC-DC Converters
- Backlighting

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low R_{DS(ON)} Ensures On-State Losses Are Minimized
- Excellent Q_{GD} x R_{DS(ON)} Product (FOM)
- Advanced Technology for DC-DC Converters
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Ordering Information (Note 4)

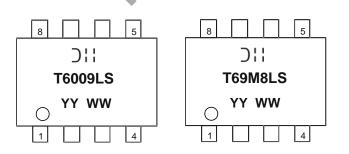
	Part Number	Case	Packaging
DMT69M8LSS-13		SO-8	2,500/Tape & Reel
Notes:	1. No purposely added lead. Fully EU Direct	tive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/	/863/EU (RoHS 3) compliant.

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking T6009LS & T69M8LS = Date Code Marking YY or \overline{YY} = Year (ex: 17 = 2017) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit V		
Drain-Source Voltage				V _{DSS}	60
Gate-Source Voltage			V _{GSS} ±16		V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	9.8 7.9	А
	t<10s	T _A = +25°C T _A = +70°C	ID	12.2 9.5	А
Maximum Continuous Body Diode Forward Current (Note 6)			IS	3	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	60	А
Avalanche Current, L = 0.1mH			I _{AS}	25	А
Avalanche Energy, L = 0.1mH			EAS	31.5	mJ

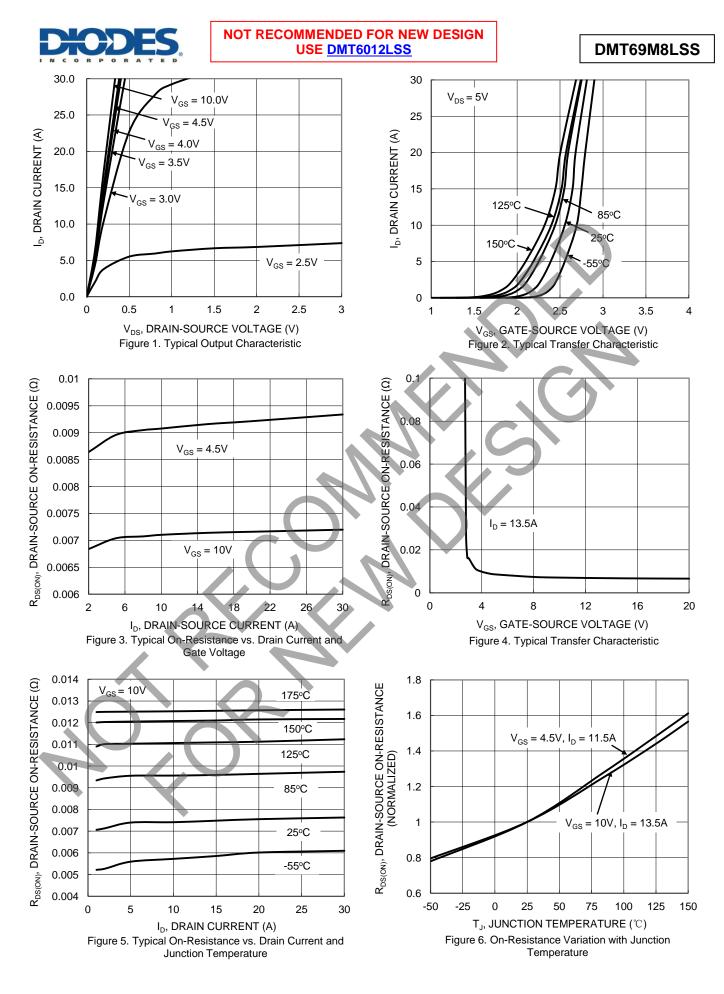
Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

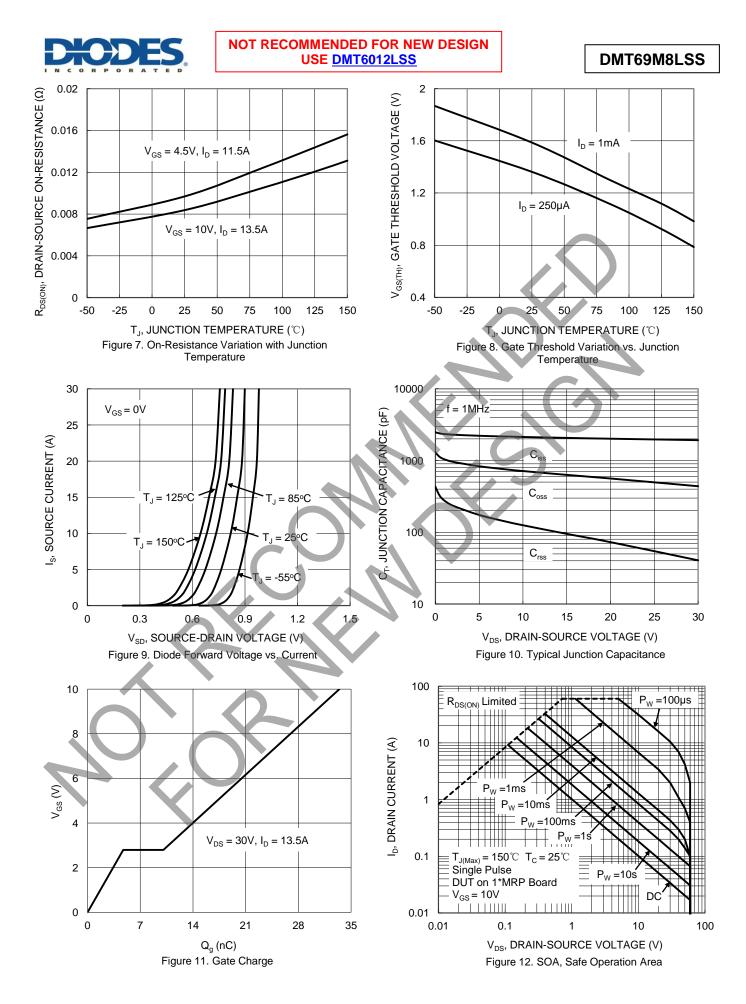
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.25	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State		100	°C/W
mermai Resistance, Junction to Ambient (Note 5)	t<10s	R _{0JA}	55.5	°C/W
Total Power Dissipation (Note 6)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{θJA}	75	°C/W
Thermal Resistance, sunction to Ambient (Note 0)	t<10s	Reja	42	°C/W
Thermal Resistance, Junction to Case (Note 6)		R _{ejc}	12	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Symbol	INUL	Тур	IVIAX	Unit	Test Condition	
Drain-Source Breakdown Voltage	BV _{DSS}	60	_		V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current	Ipss	—		1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	1 .000		1				
Gate Threshold Voltage	V _{GS(TH)}	0.7		2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Statia Duaia Causas On Decistance			9.8	12	mΩ	V _{GS} = 10V, I _D = 13.5A	
Static Drain-Source On-Resistance	RDS(ON)	_	12	14		V _{GS} = 4.5V, I _D = 11.5A	
Diode Forward Voltage	V _{SD}	_	0.9	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)	~						
Input Capacitance	Ciss	_	1,925			$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss		438	—	pF		
Reverse Transfer Capacitance	Crss		41	—			
Gate Resistance	R _G		1.7	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Q _G	_	33.5	_		V _{DS} = 30V, I _D = 13.5A	
Total Gate Charge (V _{GS} = 4.5V)	Q _G	—	15.6	—	nC		
Gate-Source Charge	Q _{GS}		4.7	_			
Gate-Drain Charge	Q _{GD}		5.3	—			
Turn-On Delay Time	t _{D(ON)}	—	4.5	—		V _{DD} = 30V, V _{GS} = 10V,	
Turn-On Rise Time	t _R	_	8.6	_	20		
Turn-Off Delay Time	t _{D(OFF)}	—	35.9		ns	$R_{G} = 6\Omega, I_{D} = 13.5A$	
Turn-Off Fall Time	t _F	_	15.7	_			
Body Diode Reverse Recovery Time	t _{RR}	_	18.2		ns		
Body Diode Reverse Recovery Charge	Q _{RR}	_	33.1	—	nC	I _F = 13.5A, di/dt = 400A/μs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:

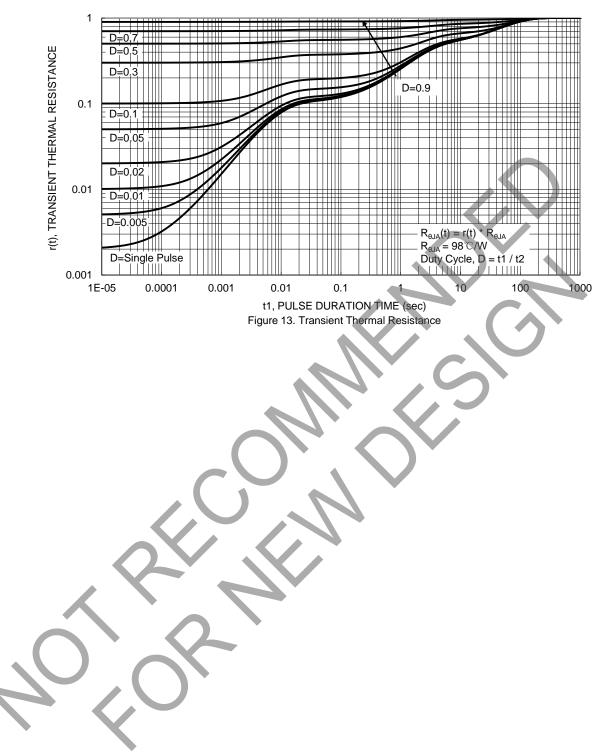






NOT RECOMMENDED FOR NEW DESIGN USE <u>DMT6012LSS</u>

DMT69M8LSS

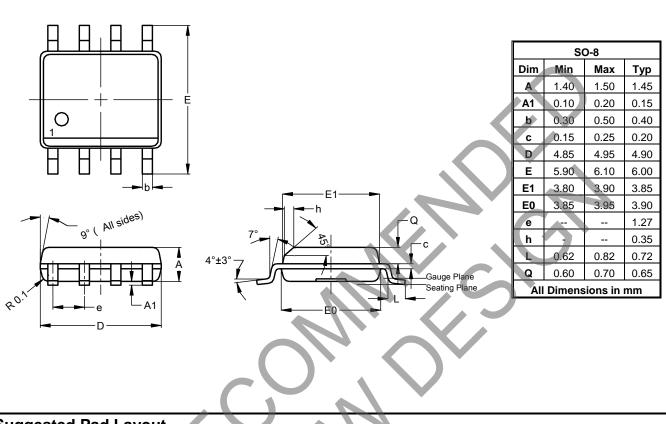




SO-8

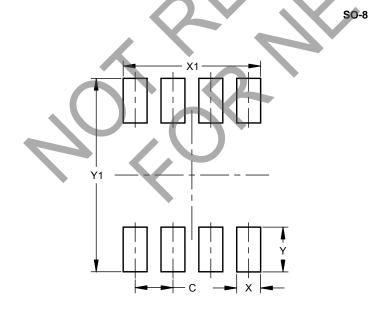
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

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Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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